

FQP11N50CF / FQPF11N50CF N-Channel QFET® FRFET® MOSFET

500 V, 11 A, 550 mΩ

Description

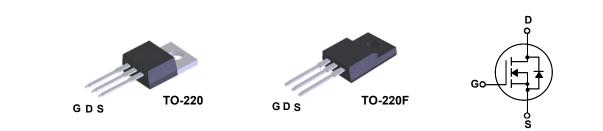
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

• 11 A, 500 V, $R_{DS(on)}$ = 550 m $\Omega(Max.)$ @V_{GS} = 10 V, I_D = 5.5 A

March 2013

- Low Gate Charge (Typ. 43 nC)
- Low C_{rss} (Typ. 20 pF)
- 100% Avalanche Tested
- Fast Recovery Body Diode (Typ. 90 ns)



Absolute Maximum Ratings

Symbol	Parameter		FQP11N50CF	FQPF11N50CF	Unit
V _{DSS}	Drain-Source Voltage		5	500	
I _D	Drain Current - Continuous (T _C = 25°C	;)	11	11 *	А
	- Continuous (T _C = 100°C)		7	7 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	44	44 *	А
V _{GSS}	Gate-Source Voltage		± 30		V
E _{AS}	Single Pulsed Avalanche Energy (Note		670		mJ
I _{AR}	Avalanche Current	(Note 1)	11		А
E _{AR}	Repetitive Avalanche Energy (Note 1)		19.5		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P _D	Power Dissipation (T _C = 25°C)		195	48	W
	- Derate above 25°C		1.56	0.39	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
Τ _L	Maximum lead temperature for soldering p 1/8" from case for 5 seconds	300		°C	

* Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FQP11N50CF	FQPF11N50CF	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.64	2.58	°C/W
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	0.5		°C/W
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQP11N50CF	FQP11N50CF	TO-220			50
FQPF11N50CF	FQPF11N50CF	TO-220F			50

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics			1	1	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	500			V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V			10	μA
		V _{DS} = 400 V, T _C = 125°C			100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
On Charact	eristics		I.		1	4
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 5.5 A		0.48	0.55	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$ (Note 4)		15		S
Dynamic C	haracteristics		I.		1	4
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V,		1515	2055	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		185	235	pF
C _{rss}	Reverse Transfer Capacitance	-		25	30	pF
Switching	Characteristics	1	1		1	1
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250 V, I _D = 11 A,		24	57	ns
t _r	Turn-On Rise Time	R _G = 25 Ω		70	150	ns
t _{d(off)}	Turn-Off Delay Time			120	250	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		75	160	ns
Qg	Total Gate Charge	V _{DS} = 400 V, I _D = 11 A,		43	55	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		8		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		19		nC
•	ce Diode Characteristics and Maximum Rat	ings		1	1	
I _S	S Maximum Continuous Drain-Source Diode Forward Current				11	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				44	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 11 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 11 A,		90		ns
Q _{rr}	Reverse Recovery Charge	$dI_{F} / dt = 100 \text{ A}/\mu \text{s}$ (Note 4)		1.5		μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature

2. L = 10 mH, I_{AS} = 11 A, V_{DD} = 50V, R_G = 25 $\Omega,$ Starting $\mbox{ T}_{J}$ = 25°C

3. I_{SD} \leq 11 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS,} Starting ~T_J = 25°C

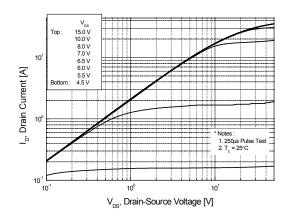
4. Pulse Test : Pulse width $\leq 300~\mu s,~\text{Duty cycle} \leq 2\%$

5. Essentially independent of operating temperature

Typical Performance Characteristics



Figure 2. Transfer Characteristics





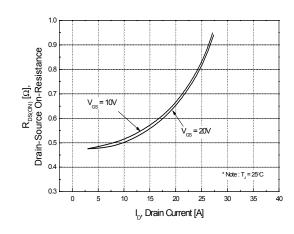
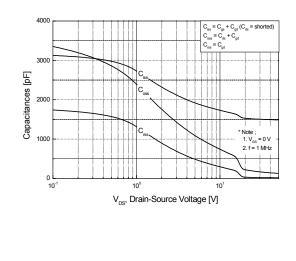


Figure 5. Capacitance Characteristics



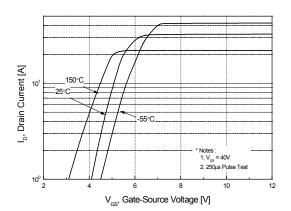


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

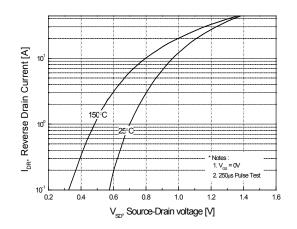
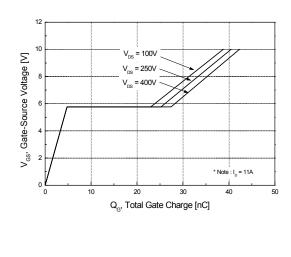
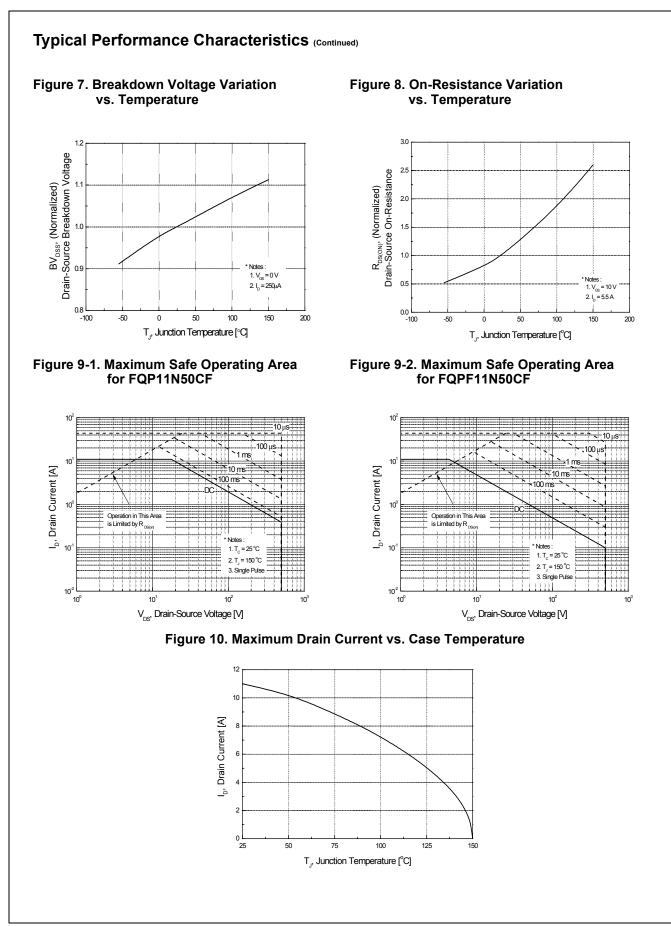


Figure 6. Gate Charge Characteristics





Typical Performance Characteristics (Continued)



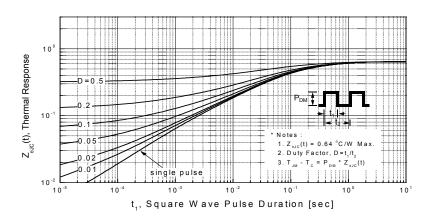
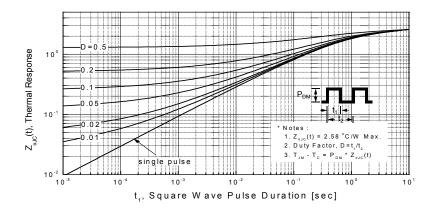
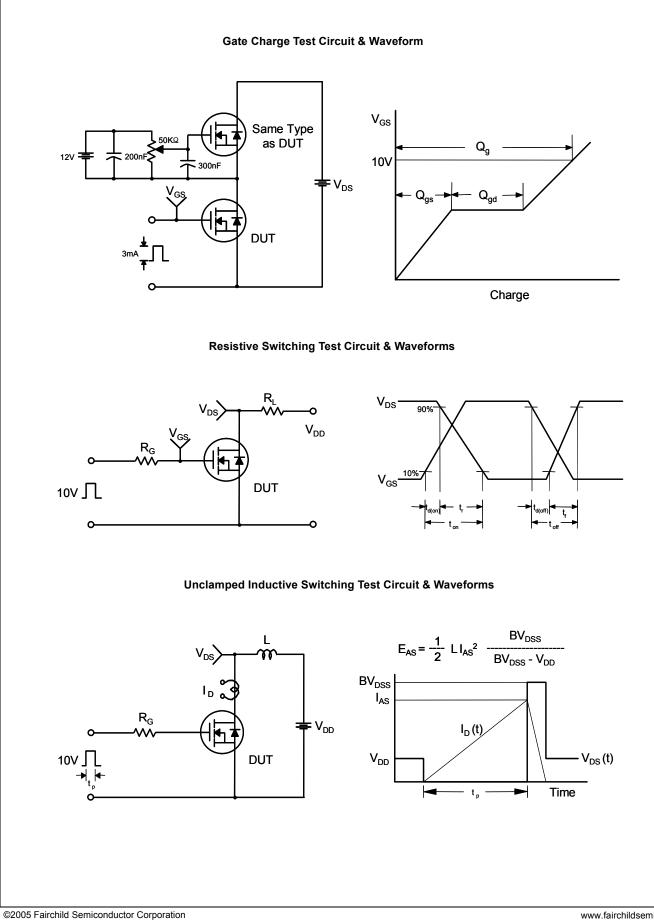


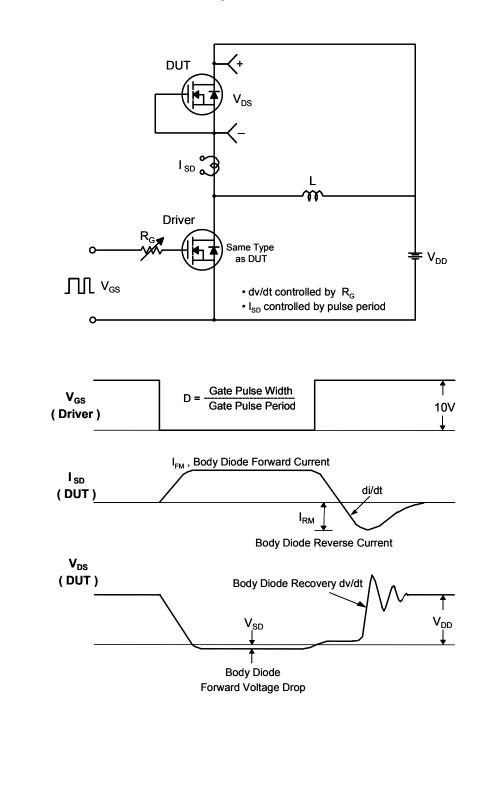
Figure 11-2. Transient Thermal Response Curve for FQPF11N50CF

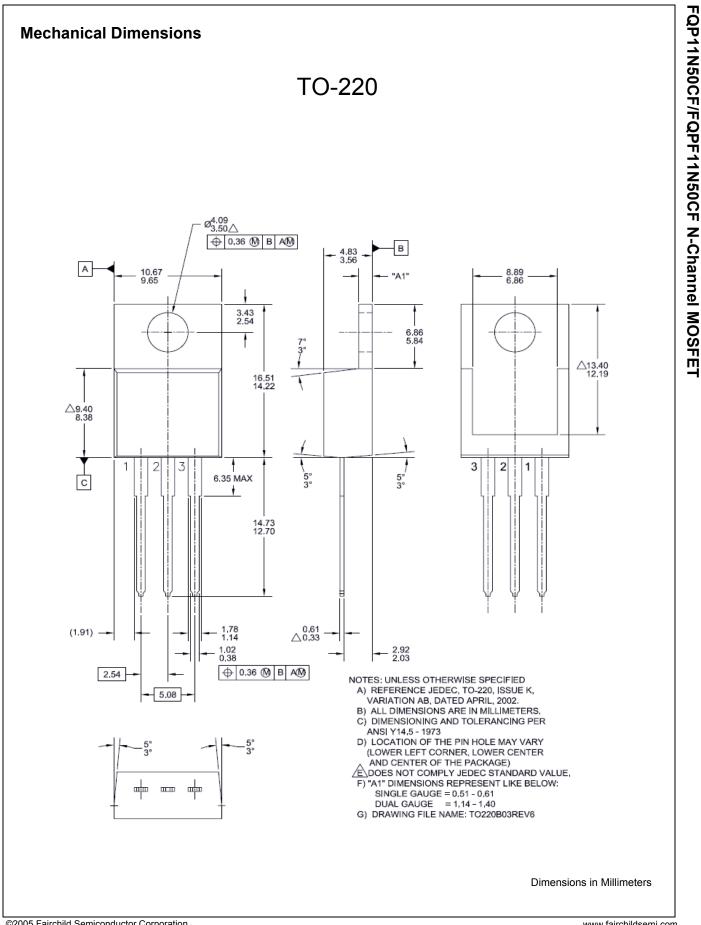


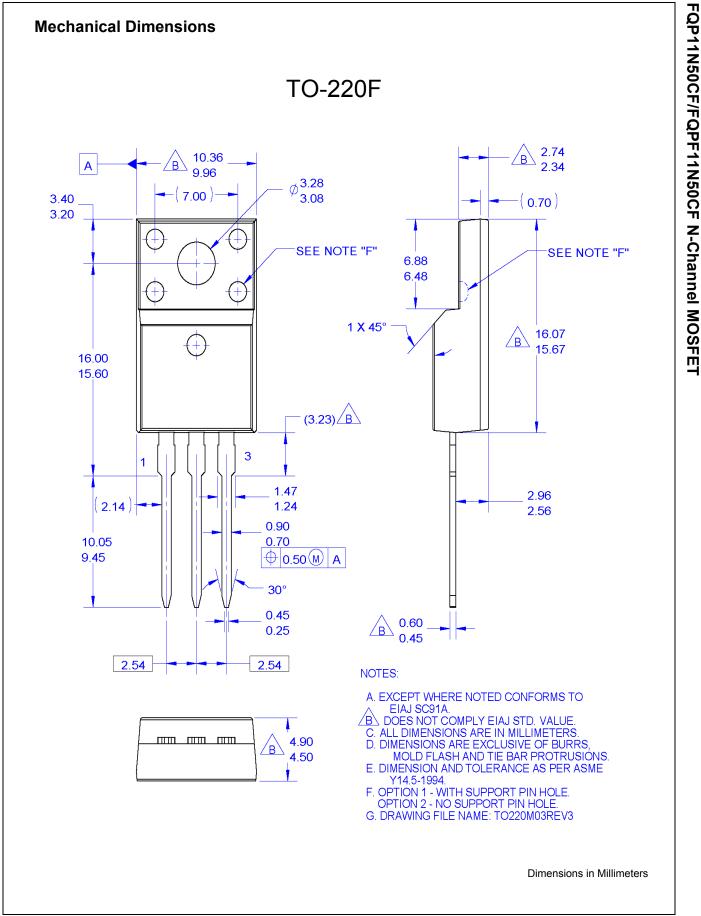


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Peak Diode Recovery dv/dt Test Circuit & Waveforms









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